PTEA415050

www.ti.com

SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

15-A, 48-V INPUT, 5-V OUTPUT, ISOLATED, 1/8th BRICK DC/DC CONVERTER

Check for Samples: PTEA415050

FEATURES

- 15-A Output Current Rating
- Input Voltage Range: 36 V to 75 V
- 91% Efficiency
- 1500 V_{DC} Isolation
- On/Off Control
- Overcurrent Protection
- Differential Remote Sense
- Adjustable Output Voltage
- Output Overvoltage Protection
- Over-Temperature Shutdown
- Undervoltage Lockout
- Standard 1/8-Brick Footprint
- UL Safety Agency Approval



DESCRIPTION

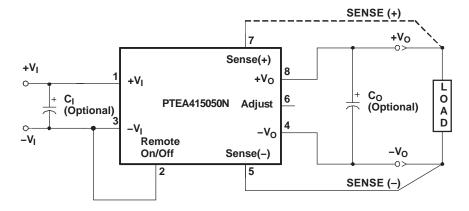
The PTEA415050 power module is a 5-V, single-output, isolated DC/DC converter, housed in an industry standard one-eighth brick package. This module is rated up to 75 W with a maximum load current of 15 A.

The PTEA415050 operates from a standard 48-V telecom central office (CO) supply and occupies less than 2.0 in² of PCB area. The modules offer OEMs a compact and flexible high-output power source in an industry standard footprint. They are suitable for distributed power applications in both telecom and computing environments, and may be used for intermediate bus converter architectures.

Features include a remote On/Off control with optional logic polarity, an undervoltage lockout (UVLO), a differential remote sense, and an industry standard output voltage adjustment using an external resistor. Protection features include output overcurrent protection (OCP), overvoltage protection (OVP), and thermal shutdown (OTP).

The module is fully integrated for stand-alone operation, and requires no additional components.

STANDARD APPLICATION





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PTEA415050



SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

www.ti.com



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this datasheet, or see the TI website at www.ti.com.

Table 1. PART NUMBERING SCHEME

	Input Voltage	Output Current	Output Voltage	Enable	Electrical Options		Pin Style
PTEA	4	15	050	N	2	Α	D
	4 = 48 V	15 = 15A	050 = 5 V	N = Negative	2 = V _O Adjust		D = Through-hole, Pb-free
				P = Positive			

ABSOLUTE MAXIMUM RATING

				UNIT				
T _A	Operating Temperature Range	Over V _I Range	-40°C to 85°C ⁽¹⁾					
V _{I, MAX}	Maximum Input Voltage	Continuous voltage	75 V					
	Maximum input voltage	Peak voltage for 100 ms duration	100 V					
P _{O, MAX}	Maximum Output Power	Maximum Output Power						
T_S	Storage Temperature	-40°C to 125°C						
	Mechanical Shock	Per Mil-STD-883, Method 2002.3 1 ms, 1/2 Sine, mounted	AD Suffix	250 G				
	Mechanical Vibrarion	15 G						
	Weight	18 grams						
	Flammability							

(1) See SOA curves or consult factory for appropriate derating.

Submit Documentation Feedback

Copyright © 2008–2010, Texas Instruments Incorporated



SLTS291B - JULY 2008-REVISED NOVEMBER 2010

ELECTRICAL CHARACTERISTICS PTEA415050

(Unless otherwise stated, $T_A = 25^{\circ}$ C, $V_I = 48$ V, $V_O = 5$ V, $C_O = 0$ μ F, and $I_O = I_O$ max)

	PARAMETER	TES	TEST CONDITIONS				UNIT
Io	Output Current	Over V _I range		0		15	Α
VI	Input Voltage Range	Over I _O Range	Over I _O Range				V
V _O tol	0.15:.17.5				±1 ⁽¹⁾		%Vo
	Set Point Voltage Tolerance			4.95	5	5.05	V
Reg _{temp}	Temperature Variation	-40°C >T _A > 85°C			±91		%Vo
Reg _{line}	Line Regulation	Over V _I range		±1		mV	
Reg _{load}	Load Regulation	Over I _O range			±1		mV
ΔV_{o} tot	Total Output Voltage Variation	Includes set-point, line,	load, -40°C >T _A > 85°C		±1.5	±3	%Vo
ΔV_{ADJ}	Output Adjust Range	P _O ≤ 75 W		-20		10	%V _O
η	Efficiency	$I_O = I_O max$			91%		
V_R	V _O Ripple (pk-pk)	20 MHz bandwidth			40		mV_{pp}
t _{tr}	Transient Response	0.1 A/µs slew rate, 50%	% to 75% I _O max		100		μs
ΔV_{tr}	Transient Response	V _O over/undershoot		200		mV	
I _{TRIP}	Overcurrent Threshold	Shutdown, followed by	auto-recovery		19		Α
OVP	Output Overvoltage Protection	Output shutdown and la		120		%Vo	
OTP	Over Temperature Protection	Temperature Measuren = 10°C nominal.		115		° C	
fs	Switching Frequency	Over V _I range		290		kHz	
UVLO	Undervoltage Lockout	V _{OFF}	V_I decreasing, $I_O = 5$ A		29.4		V
UVLO	Undervoltage Lockout	V _{HYS}		3.3		V	
On/Off In	nput: Negative Enable						
V_{IH}	Input High Voltage	Referenced to -V _I	2.4		Open ⁽²⁾	V	
V_{IL}	Input Low Voltage			-0.2		8.0	V
I _{IL}	Input Low Current				-0.2		mA
On/Off In	nput: Positive Enable						
V_{IH}	Input High Voltage	Referenced to -V _I		4.5		Open ⁽²⁾	V
V_{IL}	Input Low Voltage			-0.2		0.8	V
I _{IL}	Input Low Current				-0.2		mA
I _{ISB}	Standby Input Current	Output disabled (pin 2		0.5		mA	
C _I	External Input Capacitance	Between +V _I and -V _I		0	100		μF
Ca	External Output Canacitanas	Between +V _O and -V _O				1000	μF
Co	External Output Capacitance	Equivalent Series Resis	10			mΩ	
	Isolation Voltage	Input-to-output and input-to-case			1500		Vdc
	Isolation Capacitance	Input-to-output			1200		pF
	Isolation Resistance	Input-to-output	10			МΩ	

Copyright © 2008-2010, Texas Instruments Incorporated

Submit Documentation Feedback

If Sense(–) is not used, pin 5 must be connected to pin 4 for optimum output voltage accuracy.

The Remote On/Off input has an internal pull-up and may be controlled with an open collector (or open drain) interface. An open circuit correlates to a logic high. Consult the application notes for interface considerations.

SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

www.ti.com

ISTRUMENTS

PIN DESCRIPTIONS

 $+V_1$: The positive input for the module with respect to $-V_1$. When powering the module from a -48-V telecom central office supply, this input is connected to the primary system ground.

-V_i: The negative input supply for the module, and the 0 VDC reference for the Remote On/Off input. When powering the module from a +48-V supply, this input is connected to the 48-V return.

Remote On/Off: This input controls the On/Off status of the output voltage. It is either driven low (–V_I potential), or left open-circuit. For units identified with the NEN option, applying a logic low to this pin will enable the output. And for units identified with the PEN option, the output will be disabled.

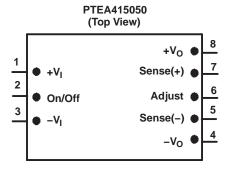
 V_O Adjust: Allows the output voltage to be trimmed by up or down between +10% and -20% of its nominal value. The adjustment method uses a single external resistor. Connecting the resistor between V_O Adjust and $-V_O$ adjusts the output voltage lower, and placing it between V_O Adjust and $+V_O$ adjusts the output higher. The calculations for the resistance value follows industry standard formulas. For further information consult the application note on output voltage adustment.

 $+V_0$: The positive power output with respect to $-V_0$, which is DC isolated from the input supply pins. If a negative output voltage is desired, $+V_0$ should be connected to the secondary circuit common and the output taken from $-V_0$.

 $-V_0$: The negative power output with respect to $+V_0$, which is DC isolated from the input supply pins. This output is normally connected to the secondary circuit common when a positive output voltage is desired.

Sense(+): Provides the converter with an output sense capability to regulate the set-point voltage directly at the load. When used with Sense(-), the regulation circuitry will compensate for voltage drop between the converter and the load. The pin may be left open circuit, but connecting it to $+V_O$ will improve load regulation. If a series inductor is used for filtering between the module output and load, this pin must be connected directly to the module output to ensure good control design stability.

Sense(-): Provides the converter with an output sense capability when used in conjunction with Sense(+) input. For optimum output voltage accuracy this pin should always be connected to $-V_0$.

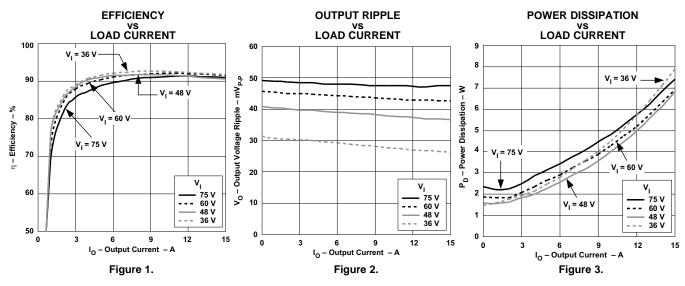


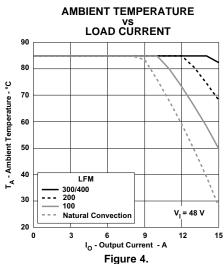


SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

TYPICAL CHARACTERISTICS

PTEA415050, $V_0 = 5 V^{(1)} (2)$





- (1) All data listed in Figure 1, Figure 2, and Figure 3 have been developed from actual products tested at 25°C. This data is considered typical data for the dc-dc converter.
- (2) The temperature derating curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature. Derating limits apply to modules soldered directly to a 100–mm × 100–mm, double-sided PCB with 2 oz. copper. For surface mount packages, multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 4.

Copyright © 2008–2010, Texas Instruments Incorporated

Submit Documentation Feedback

TEXAS INSTRUMENTS

SLTS291B-JULY 2008-REVISED NOVEMBER 2010

www.ti.com

APPLICATION INFORMATION

Operating Features and System Considerations for the PTEA415050 DC/DC Converter

Overcurrent Protection

To protect against load faults, these converters incorporate output overcurrent protection. Applying a load to the output that exceeds the converter's overcurrent threshold (see applicable specification) will cause the output voltage to momentarily fold back, and then shut down. Following shutdown the module will periodically attempt to automatically recover by initiating a soft-start power-up. This is often described as a *hiccup* mode of operation, whereby the module continues in the cycle of successive shutdown and power up until the load fault is removed. Once the fault is removed, the converter automatically recovers and returns to normal operation.

Output Overvoltage Protection

Each converter incorporates protection circuitry that continually senses for an output overvoltage (OV) condition. The OV threshold is set approximately 20% higher than the nominal output voltage. If the converter output voltage exceeds this threshold, the converter is immediately shut down and remains in a latched-off state. To resume normal operation the converter must be actively reset. This can only be done by momentarily removing the input power to the converter. For fail-safe operation and redundancy, the OV protection uses circuitry that is independent of the converter's internal feedback loop.

Overtemperature Protection

Overtemperature protection is provided by an internal temperature sensor, which closely monitors the temperature of the converter's printed circuit board (PCB). If the sensor exceeds a temperature of approximately 115°C, the converter will shut down. The converter will then automatically restart when the sensed temperature drops back to approximately 105°C. When operated outside its recommended thermal derating envelope (see data sheet SOA curves), the converter will typically cycle on and off at intervals from a few seconds to one or two minutes. This is to ensure that the internal components are not permanently damaged from excessive thermal stress.

Undervoltage Lockout

The Undervoltage lockout (UVLO) is designed to prevent the operation of the converter until the input voltage is at the minimum input voltage. This prevents high start-up current during normal power-up of the converter, and minimizes the current drain from the input source during low input voltage conditions. The UVLO circuitry also overrides the operation of the *Remote On/Off* control.

Primary-Secondary Isolation

These converters incorporate electrical isolation between the input terminals (primary) and the output terminals (secondary). All converters are production tested to a withstand voltage of 1500 VDC. This specification complies with UL60950 and EN60950 requirements. This allows the converter to be configured for either a positive or negative input voltage source. The data sheet *Pin Descriptions* section provides guidance as to the correct reference that must be used for the external control signals.

Input Current Limiting

The converter is not internally fused. For safety and overall system protection, the maximum input current to the converter must be limited. Active or passive current limiting can be used. Passive current limiting can be a fast acting fuse. A 125-V fuse, rated no more than 10 A, is recommended. Active current limiting can be implemented with a current limited *Hot-Swap* controller.

Thermal Considerations

Airflow may be necessary to ensure that the module can supply the desired load current in environments with elevated ambient temperatures. The required airflow rate may be determined from the Safe Operating Area (SOA) thermal derating chart (see typical characteristics).

Submit Documentation Feedback

Product Folder Links: PTEA415050



SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

Differential Remote Sense

The remote sense pins allows the converter to precisely regulate the DC output voltage at a remote location. This might be a power plane on an inner layer of the host PCB. Connecting Sense(+) directly to $+V_O$, and Sense(-) to $-V_O$ will improve output voltage accuracy. In the event that the sense pins are left open-circuit, an internal $10-\Omega$ resistor between each sense pin and its corresponding output prevents an excessive rise in the output voltage. For practical reasons, the amount of IR voltage compensation should be limited to 0.5 V maximum.

The remote sense feature is designed to compensate for limited amounts of *IR* voltage drop. It is **not** intended to compensate for the forward drop of a non-linear or frequency dependent components that may be placed in series with the converter output. Examples of such components include OR-ing diodes, filter inductors, ferrite beads, and fuses. Enclosing these components with the remote sense connections effectively places them inside the regulation control loop, which can affect the stability of the regulator.

Submit Documentation Feedback

Product Folder Links: PTEA415050

TEXAS INSTRUMENTS

SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

www.ti.com

Using the Remote On/Off Function on the PTEA415050 DC/DC Converter

For applications requiring output voltage On/Off control, the PTEA415050 DC/DC converter incorporate a Remote On/Off control (pin 2). This feature can be used to switch the module off without removing the applied input source voltage. When placed in the Off state, the standby current drawn from the input source is typically reduced to 3 mA.

Negative Output Enable (NEN)

Models using the negative enable option, the *Remote On/Off* (pin 2) control must be driven to a logic low voltage for the converter to produce an output. This is accomplished by either permanently connecting pin 2 to $-V_1$ (pin 3), or driving it low with an external control signal. Table 2 shows the input requirements of pin 2 for those modules with the *NEN* option.

Table 2. On/Off Control Requirements for Negative Enable

	PARAMETER	MIN	TYP	MAX	UNITS
V _{IH}	Disable	2.4		20	V
V_{IL}	Enable	-0.2		8.0	
V _{o/c}	Open-Circuit		9	15	
I	Pin 2 at -V _I			-0.75	mA

Positive Output Enable (PEN)

For those models with the positive enable (PEN) option, leaving pin 2 open circuit, (or driving it to an equivalent logic high voltage), will enable the converter output. This allows the module to produce an output voltage whenever a valid input source voltage is applied to $+V_1$ with respect to $-V_1$. If a logic-low signal is then applied to pin 2 the converter output is disabled. Table 3 gives the input requirements of pin 2 for modules with the *PEN* option.

Table 3. On/Off Control Requirements for Positive Enable

	PARAMETER	MIN	TYP	MAX	UNITS
V_{IH}	Enable	4.5		20	V
V_{IL}	Disable	-0.2		8.0	
V _{o/c}	Open-Circuit		5	7	
II	Pin 2 at –V _I			-0.5	mA

Notes:

- 1. The Remote On/Off control uses $-V_1$ (pin 3) as its ground reference. All voltages are with respect to $-V_1$.
- 2. An open-collector device (preferably a discrete transistor) is recommended. A pull-up resistor is not required. If one is added the pull-up voltage should not exceed 20 V.

Caution: Do not use a pull-resistor to $+V_l$ (pin 1). The remote On/Off control has a maximum input voltage of 20 V. Exceeding this voltage will overstress, and possibly damage, the converter.

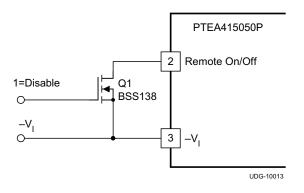
- 3. The *Remote On/Off* pin may be controlled with devices that have a totem-pole output. This is provided the output high level voltage (V_{OH}) meets the module's minimum V_{IH} specified in Table 2. If a TTL gate is used, a pull-up resistor may be required to the logic supply voltage.
- 4. The converter incorporates an *undervoltage lockout* (UVLO). The UVLO keeps the converter off until the input voltage is close to the minimum specified operating voltage. This is regardless of the state of the *Remote On/Off* control. Consult the product specification for the UVLO input voltage thresholds.

Submit Documentation Feedback

Copyright © 2008–2010, Texas Instruments Incorporated

SLTS291B - JULY 2008 - REVISED NOVEMBER 2010

Turn-On: With a valid input source voltage applied, the converter produces a regulated output voltage within 10 ms of the output being enabled. Figure 6 shows the output response of the PTEA following the removal of the logic-low signal from the *Remote On/Off* (pin 2); see Figure 5. This corresponds to the rise in V_{EN} in Figure 6. Although the rise-time of the output voltage is short (<5 ms), the indicated delay time will vary depending upon the input voltage and the module's internal timing. The waveforms were measured with 48 VDC input voltage, and a 15-A resistive load.



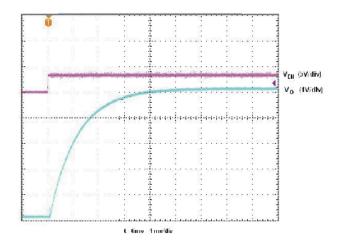


Figure 5. Recommended Remote On/Off Control

Figure 6. Power Up

Copyright © 2008–2010, Texas Instruments Incorporated

Adjusting the Output Voltage of the PTEA415050 Isolated DC/DC Converter

NSTRUMENTS

www.ti.com

The output voltage adjustment of the PTEA415050 isolated DC/DC converter follows the standard adopted by popular 1/8-brick DC/DC converters. Adjustment is accomplished with a single external resistor that can adjust the output voltage from -20% to +10% of the nominal set-point voltage. The placement of the resistor determines the direction of adjustment, up or down, and the value of the magnitude of adjustment. To ensure good V_{Ω} setpoint accuracy, a 1% maximum tolerance resistor is recommended.

Adjust Up: To increase the output voltage add a resistor, R1, between V_0 Adjust (pin 6) and Sense(+) (pin 7).

Adjust Down: Add a resistor, (R2), between V_O Adjust (pin 6) and Sense(-) (pin 5).

Refer to Figure 7 for the placement of the required resistor, R1 or (R2).

The values of R1 [adjust up], and (R2) [adjust down], can be calculated using the following formulas.

$$R1 = \frac{5.11 \text{ V}_{\text{O}} (100 + \Delta\%)}{1.225 \Delta\%} - \frac{511}{\Delta\%} - 10.22 \text{ (k}\Omega)$$
(1)

$$(R2) = 5.11 \frac{100}{\Delta\%} - 10.22 \quad (k\Omega)$$
 (2)

Where:

 Δ % = Amount of adjustment in %

V_O = Original set-point voltage

Notes:

- 1. Use a 1% resistor for either the R1 or (R2). Place the resistor as close to the converter as possible.
- 2. If V_O is increased, the maximum load current must be derated according to the following equation.

$$I_{O}(max) = \frac{V_{O} \times I_{O}(rated)}{V_{A}}$$

where

- V_O is the original set-point voltage
- V_A is the adjusted output voltage (measured between pin 8 and pin 4)

(3)

In any instance, the load current must not exceed the converter's maximum rated output current of 15 A.

3. The overvoltage threshold is fixed, and is set approximately 20% above the nominal output voltage. Adjusting the output voltage higher reduces the voltage margin between the adjusted output voltage and the overvoltage (OV) protection threshold. This could make the module sensitive to OV fault detection, as a result of random noise and load transients.

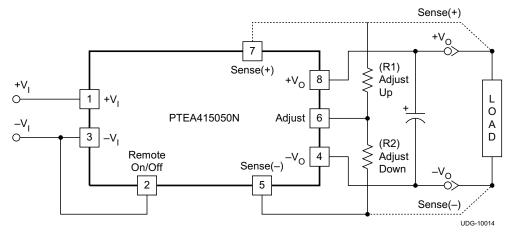


Figure 7.

Submit Documentation Feedback

Copyright © 2008-2010, Texas Instruments Incorporated

SLTS291B -JULY 2008-REVISED NOVEMBER 2010

Table 4. Adjustment Resistor Values

V _O (nom) % Adjust (V)	Adjusted Output Voltage (V)	Trim-Up R _{ADJ} R1 (kΩ)	Trim-Down R _{ADJ} R2 (kΩ)
+10	5.50	169	Open
+ 9	5.45	187	Open
+ 8	5.40	205	Open
+ 7	5.35	237	Open
+ 6	5.30	274	Open
+ 5	5.25	324	Open
+ 4	5.20	402	Open
+ 3	5.15	536	Open
+ 2	5.10	806	Open
+ 1	5.05	1580	Open
0	5.00	Open	Open
-1	4.95	Open	499
-2	4.90	Open	243
-3	4.85	Open	158
-4	4.80	Open	118
-5	4.75	Open	90.9
-6	4.70	Open	75.0
-7	4.65	Open	63.4
-8	4.60	Open	53.6
-9	4.55	Open	46.4
-10	4.50	Open	41.2
-11	4.45	Open	36.5
-12	4.40	Open	32.4
-13	4.35	Open	28.7
-14	4.30	Open	26.1
-15	4.25	Open	23.7
-16	4.20	Open	21.5
-17	4.15	Open	19.6
-18	4.10	Open	18.2
-19	4.05	Open	16.5
-20	4.00	Open	15.4



PACKAGE OPTION ADDENDUM

21-May-2017

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PTEA415050N2AD	NRND	Through- Hole Module	EAW	8	15	RoHS (In Work) & non-Green	SN	N / A for Pkg Type	-40 to 85		
PTEA415050P2AD	NRND	Through- Hole Module	EAW	8	15	RoHS (In Work) & non-Green	SN	N / A for Pkg Type	-40 to 85		

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

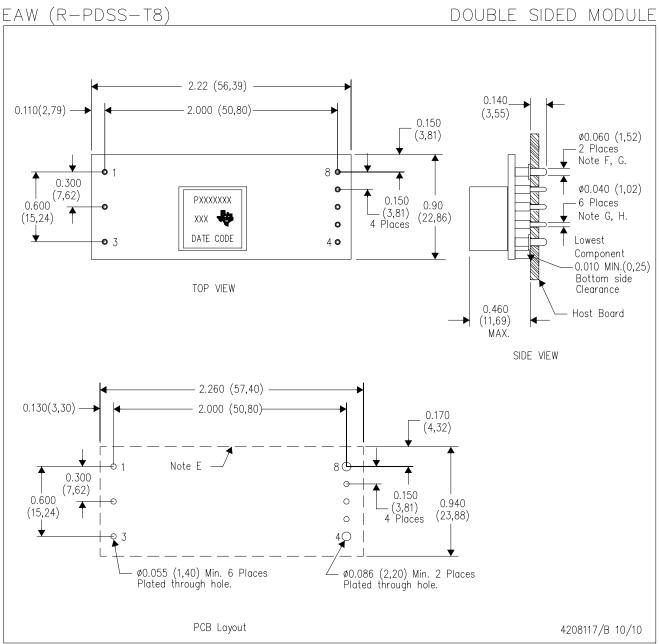
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.





21-May-2017



NOTES:

- A. All linear dimensions are in inches (mm).
- B. This drawing is subject to change without notice.
- C. 2 place decimals are ± 0.020 ($\pm 0,51$ mm).
- D. 3 place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended keep out area for user components.
- F. Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
- G. All pins: Material Copper Alloy Finish — Tin (100%) over Nickel plate



IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (http://www.ti.com/sc/docs/stdterms.htm) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.